WHAT IS CLAIMED IS:

- 1. A magnetic field sensor comprising:
- a soft magnetic core formed in a semiconductor substrate to construct a closed-magnetic circuit;
- a magnetic field sensing coil formed by a metal film in a structure of winding magnetic core; and
- a drive line for exciting the soft magnetic core by directly applying an electric current thereto.
- 2. The magnetic field sensor of claim 1, wherein the drive line is formed in a rectangular angle to the magnetic field sensing coil.
- 3. The magnetic field sensor of claim 2, wherein the drive line is connected to both ends of the soft magnetic core in a length direction.
- 4. The magnetic field sensor of claim 3, wherein the length direction of the soft magnetic core is in a magnetic field sensing axis.

- 5. The magnetic field sensor of claim 1, wherein the magnetic field sensing coil is wound in a solenoid pattern.
 - 6. A method for fabricating a magnetic field sensor comprising the steps of:

forming a pattern on a semiconductor substrate, corresponding to a lower part of the magnetic field sensing coil, and forming the lower part by first-putting metal into the pattern;

forming a first insulation film on the semiconductor substrate where the metal is first-put;

accumulating a soft magnetic material film on the first insulation film, and forming a soft magnetic core by patterning and etching;

forming a second insulation film on the semiconductor substrate where the soft magnetic core is formed;

forming on the second insulation film a penetrating hole for fluidly communicating with the first-put metal forming the lower part, and also forming a penetrating hole for fluidly communicating with the soft magnetic core;

forming a pattern corresponding to an upper part of the magnetic field sensing coil on the second insulation film, and forming the upper part by second-putting metal

into the pattern; and

forming a protection film on the semiconductor substrate where the metal is second-put.

7. The method for fabricating a magnetic field sensor of claim 6, wherein the method for forming of the lower part of the magnetic field sensing coil comprises the steps of:

forming an oxide film on the semiconductor substrate;

forming a conductive film on the oxide film;

applying a photoresist on the conductive film;

forming a pattern corresponding to a lower part of the magnetic field sensing coil by exposure and development;

first-putting metal into an upper part of the semiconductor substrate such that the metal is filled in the patterned area; and

removing the photoresist remaining after forming the pattern, and the conductive film which is the lower part of the remaining photoresist.

8. The method for fabricating a magnetic field sensor of claim 6, wherein the

method for forming the soft magnetic core comprises the steps of:

forming a soft magnetic material film on the first insulation film;

applying a photoresist on the soft magnetic material film;

forming a pattern on the photoresist, corresponding to the soft magnetic core, by exposure and development;

removing the soft magnetic material film except for the patterned area; and removing the photoresist remaining after forming the pattern.

9. The method for fabricating a magnetic field sensor of claim 6, wherein the method for forming an upper part of the soft magnetic core comprises the steps of:

forming a conductive film on the second insulation film where the penetrating hole is formed;

applying a photoresist on the conductive film;

forming a pattern on the photoresist, corresponding to an upper part of the magnetic field sensing coil, by exposure and development;

second-putting metal to fill in the patterned area; and

removing the photoresist remaining after forming the pattern and the conductive under the remaining photoresist.

- 10. The method for fabricating a magnetic field sensor of claim 6, wherein the penetrating hole fluidly communicated with the soft magnetic core is formed on both ends of the soft magnetic core in a length direction.
- 11. The method for fabricating a magnetic field sensor of claim 10, wherein the length direction of the soft magnetic core is formed toward magnetic field sensing axis.
- 12. The method for fabricating a magnetic field sensor of claim 6, wherein the magnetic field sensing coil is wound in a solenoid pattern.